

## **AS3930** Single Channel Low Frequency Wakeup Receiver

#### **General Description**

The AS3930 is a single-channel low power ASK receiver that is able to generate a wake-up upon detection of a data signal which uses a LF carrier frequency between 110 - 150 kHz. The integrated correlator can be used for detection of a programmable 16-bit wake-up pattern.

The AS3930 provides a digital RSSI value, it supports a programmable data rate. The AS3930 offers a real-time clock (RTC), which is either derived from a crystal oscillator or the internal RC oscillator.

The programmable features of AS3930 enable to optimize its settings for achieving a longer distance while retaining a reliable wake-up generation. The sensitivity level of AS3930 can be adjusted in presence of a strong field or in noisy environments. The device is available in a 16-pin TSSOP and a 16-LD QFN (4x4) package.

Ordering Information and Content Guide appear at end of datasheet.

#### **Key Benefits & Features**

The benefits and features of AS3930, Single Channel Low Frequency Wakeup Receiver are listed below:

Figure 1: Added Value of Using AS3930

| Benefits                                      | Features   |
|---|--|
| Enables low power active tags                 | Single channel ASK wake-up receiver                  |
| Selectable carrier frequency                  | Carrier frequency range 110 – 150 kHz                |
| Highly resistant to false wake-ups            | 16-bit programmable wake-up pattern                  |
| Improved immunity to false wake-ups           | Supporting doubling of wake-up pattern               |
| Allows frequency only detection               | Wake-up without pattern detection selectable         |
| Improved range with best-in-class sensitivity | Wake-up sensitivity 100µVRMS (typ.)                  |
| Adjustable range                              | Sensitivity level adjustable                         |
| Provides tracking of false wake-ups           | False wake-up counter                                |
| Ensures wake-up in a noise environment        | Periodical forced wake-up supported (1s – 2h)        |
| Extended battery life                         | Current consumption in listening mode 1.37 µA (typ.) |
| Flexible clock configuration                  | RTC based 32 kHz XTAL, RC-OSC, or external clock     |

| Benefits                     | Features   |
|------------------------------|--|
| Operates from a 3V battery   | Operating supply range $2.4V - 3.6V$ (TA = $25^{\circ}C$ ) |
| Industrial temperature range | Operation temperature range -40°C to +85°C                 |

## Applications

The AS3930, Single Channel Low Frequency Wakeup Receiver is ideal for Active RFID tags, real-time location systems, operator identification, access control, and wireless sensors.



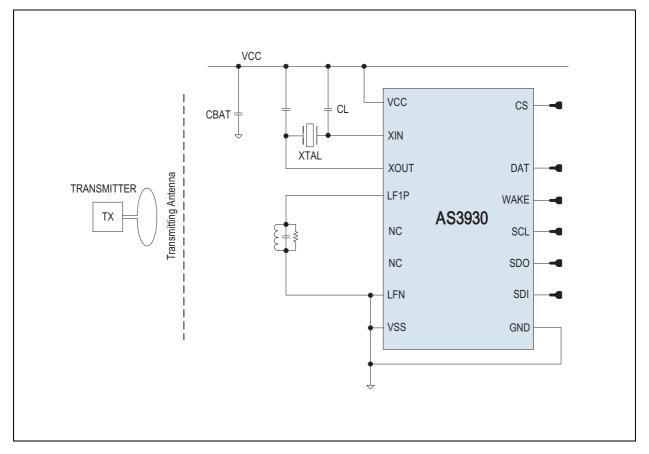
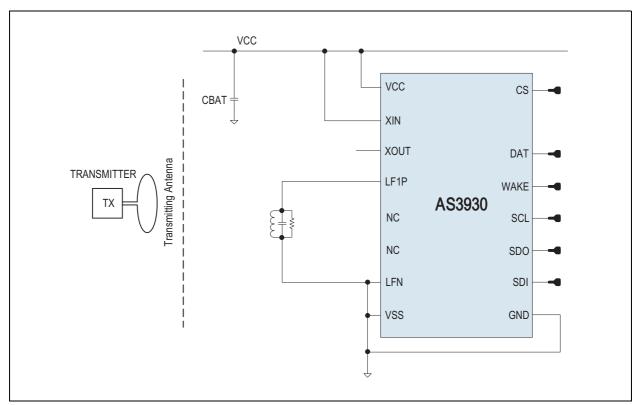
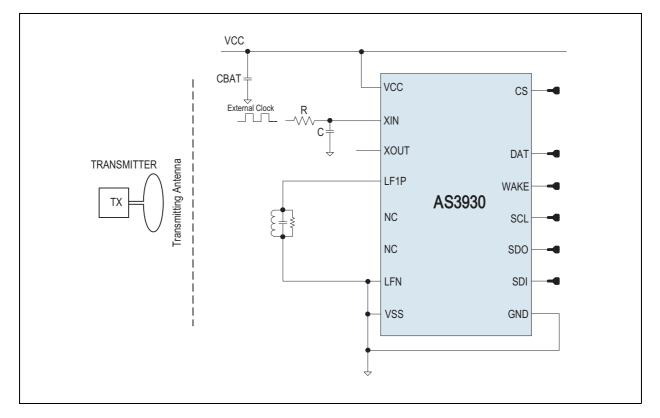


Figure 3: AS3930 Typical Application Diagram without Crystal Oscillator



#### Figure 4:

AS3930 Typical Application Diagram with Clock from External Source

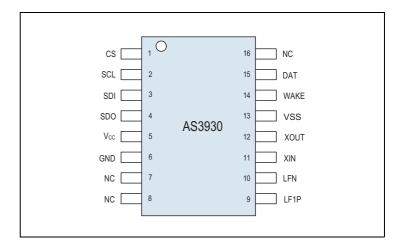




## **Pin Assignments**

### 16-pin TSSOP

Figure 5: Pin Diagram (Top View)



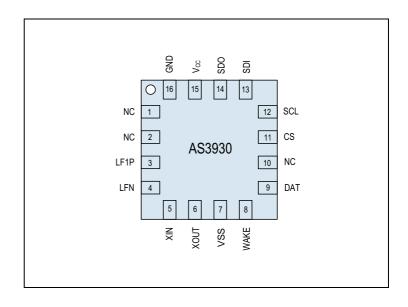
#### Figure 6: Pin Description

| Pin Number | Pin Name        | Pin Type                  | Description                               |
|------------|-----------------|---------------------------|---|
| 1          | CS              |                           | Chip select                               |
| 2          | SCL             | Digital input             | SDI interface clock                       |
| 3          | SDI             |                           | SDI data input                            |
| 4          | SDO             | Digital output / tristate | SDI data output (tristate when CS is low) |
| 5          | V <sub>CC</sub> | Supply and                | Positive supply voltage                   |
| 6          | GND             | Supply pad                | Negative supply voltage                   |
| 7          | NC              |                           | Not Connected                             |
| 8          | NC              | -                         | Not connected                             |
| 9          | LF1P            |                           | Input antenna                             |
| 10         | LFN             | Apples 1/O                | Antenna ground                            |
| 11         | XIN             | Analog I/O                | Crystal oscillator input                  |
| 12         | XOUT            |                           | Crystal oscillator output                 |
| 13         | V <sub>SS</sub> | Supply pad                | Substrate                                 |
| 14         | WAKE            | Digital output            | Wake-up output IRQ                        |
| 15         | DAT             | Digital output            | Data output                               |
| 16         | NC              | -                         | Not connected                             |



#### QFN 4x4 16 LD

Figure 7: Pin Diagram (Top View)



#### Figure 8: Pin Description

| Pin Number | Pin Name        | Pin Type                  | Description                               |
|------------|-----------------|---------------------------|---|
| 1          | NC              | -                         | Not connected                             |
| 2          | NC              | -                         | Not connected                             |
| 3          | LF1P            |                           | Input antenna                             |
| 4          | LFN             |                           | Antenna ground                            |
| 5          | XIN             | Analog I/O                | Crystal oscillator input                  |
| 6          | XOUT            |                           | Crystal oscillator output                 |
| 7          | V <sub>SS</sub> | Supply pad                | Substrate                                 |
| 8          | WAKE            | Digital output            | Wake-up output IRQ                        |
| 9          | DAT             | Digital output            | Data output                               |
| 10         | NC              | -                         | Not connected                             |
| 11         | CS              |                           | Chip select                               |
| 12         | SCL             | Digital input             | SDI interface clock                       |
| 13         | SDI             |                           | SDI data input                            |
| 14         | SDO             | Digital output / tristate | SDI data output (tristate when CS is low) |
| 15         | V <sub>CC</sub> | Supply pad                | Positive supply voltage                   |
| 16         | GND             | Supply pad                | Negative supply voltage                   |



### Absolute Maximum Ratings

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in Electrical Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### Figure 9: Absolute Maximum Ratings

| Parameter  | Min                     | Max         | Unit       | Note  |  |  |  |  |
|--|-------------------------|-------------|------------|---|--|--|--|--|
|  | Ele                     | ectrical Pa | rameters   |   |  |  |  |  |
| DC supply voltage (V <sub>DD</sub> )                                       | -0.5                    | 5           | V          |   |  |  |  |  |
| Input pin voltage (V <sub>IN</sub> )                                       | -0.5                    | 5           | V          |   |  |  |  |  |
| Input current (latch up immunity)<br>(I <sub>SOURCE</sub> )                | -100                    | 100         | mA         | Norm: Jedec 78  |  |  |  |  |
|  | Electrostatic Discharge |             |            |   |  |  |  |  |
| Electrostatic discharge (ESD)  | ±2                      |             | kV         | Norm: MIL 883 E method 3015 (HBM)   |  |  |  |  |
|  | Contin                  | uous Pow    | er Dissipa | tion  |  |  |  |  |
| Total power dissipation<br>(all supplies and outputs)<br>(P <sub>t</sub> ) |                         | 0.07        | mW         |   |  |  |  |  |
| Tem  | perature R              | langes an   | d Storage  | Conditions  |  |  |  |  |
| Storage temperature (T <sub>strg</sub> )                                   | -65                     | 150         | °C         |   |  |  |  |  |
| Package body temperature<br>(T <sub>body</sub> )                           |                         | 260         | °C         | Norm: IPC/JEDEC J-STD-020<br>The reflow peak soldering temperature<br>(body temperature) is specified according<br>IPC/JEDEC J-STD-020 "Moisture/Reflow<br>Sensitivity Classification for Non-hermetic<br>Solid State Surface Mount Devices". |  |  |  |  |
| Humidity non-condensing  | 5                       | 85          | %          |   |  |  |  |  |
| Moisture Sensitivity Level (MSL)   | 3                       | 1           |            | Represents a maximum floor life time of 168h  |  |  |  |  |



## **Electrical Characteristics**

Figure 10: Electrical Characteristics

| Symbol            | Parameter  | Conditions   | Min                       | Тур                     | Max                      | Unit |  |  |  |  |  |
|-------------------|--|--|---------------------------|-------------------------|--------------------------|------|--|--|--|--|--|
|                   | Operating Conditions                                 |  |                           |                         |                          |      |  |  |  |  |  |
| V <sub>DD</sub>   | Positive supply voltage                              |  | 2.4                       |                         | 3.6                      | V    |  |  |  |  |  |
| V <sub>SS</sub>   | Negative supply voltage                              |  | 0                         |                         | 0                        | V    |  |  |  |  |  |
| T <sub>AMB</sub>  | Ambient temperature                                  |  | -40                       |                         | 85                       | °C   |  |  |  |  |  |
|                   | DC/AC Characteristics for Digital Inputs and Outputs |  |                           |                         |                          |      |  |  |  |  |  |
|                   | CMOS Input   |  |                           |                         |                          |      |  |  |  |  |  |
| V <sub>IH</sub>   | High level input voltage                             |  | 0.58*<br>V <sub>DD</sub>  | 0.7*<br>V <sub>DD</sub> | 0.83*<br>V <sub>DD</sub> | V    |  |  |  |  |  |
| V <sub>IL</sub>   | Low level input voltage                              |  | 0.125*<br>V <sub>DD</sub> | 0.2*<br>V <sub>DD</sub> | 0.3*<br>V <sub>DD</sub>  | V    |  |  |  |  |  |
| I <sub>LEAK</sub> | Input leakage current                                |  |                           |                         | 100                      | nA   |  |  |  |  |  |
|                   |  | CMOS Output  |                           | 1                       | I                        |      |  |  |  |  |  |
| V <sub>OH</sub>   | High level output voltage                            | With a load current of 1mA                                     | V <sub>DD</sub> -<br>0.4  |                         |                          | V    |  |  |  |  |  |
| V <sub>OL</sub>   | Low level output voltage                             |  |                           |                         | V <sub>SS</sub> +<br>0.4 | V    |  |  |  |  |  |
| CL                | Capacitive load                                      | For a clock frequency of 1 MHz                                 |                           |                         | 400                      | pF   |  |  |  |  |  |
|                   | Tristate CMOS Output                                 |  |                           |                         |                          |      |  |  |  |  |  |
| V <sub>OH</sub>   | High level output voltage                            | With a load current of 1mA                                     | V <sub>DD</sub> -<br>0.4  |                         |                          | V    |  |  |  |  |  |
| V <sub>OL</sub>   | Low level output voltage                             | with a load current of TMA                                     |                           |                         | V <sub>SS</sub> +<br>0.4 | V    |  |  |  |  |  |
| I <sub>OZ</sub>   | Tristate leakage current                             | To $V_{\mbox{\scriptsize DD}}$ and $V_{\mbox{\scriptsize SS}}$ |                           |                         | 100                      | nA   |  |  |  |  |  |



#### Figure 11: Electrical System Specifications

| Symbol          | Parameter  | Conditions  | Min | Тур    | Max | Unit  |
|-----------------|--|---|-----|--------|-----|-------|
|                 | I  | Input Characteristics   |     |        |     |       |
| R <sub>IN</sub> | Input Impedance  | In case no antenna damper is set (R1<4>=0)  |     | 2      |     | MΩ    |
| Fmin            | Minimum Input<br>Frequency   |   |     | 110    |     | kHz   |
| Fmax            | Maximum Input<br>Frequency   |   |     | 150    |     | kHz   |
|                 |  | Current Consumption   | 1   | I      | I   |       |
| IPWD            | Power Down Mode  |   |     | 400    |     | nA    |
| ICHRC           | Current Consumption<br>in standard listening<br>mode with channel<br>active all the time and<br>RC-oscillator as RTC |   |     | 2.7    |     | μΑ    |
|                 | Current Consumption  | 11% Duty Cycle  |     | 1.37   |     |       |
| ICHOORC         | in ON/OFF mode and<br>RC-oscillator as RTC   | 50% Duty Cycle  |     | 2      |     | μA    |
| ICHXT           | Current Consumption<br>in standard listening<br>mode and crystal<br>oscillator as RTC                                |   |     | 3.5    | 5.9 | μA    |
| IDATA           | Current Consumption<br>in Preamble detection<br>/ Pattern correlation /<br>Data receiving mode<br>(RC-oscillator)    | With 125 kHz carrier frequency<br>and 1kbps data-rate.<br>No load on the output pins.   |     | 5.3    | 9   | μΑ    |
|                 |  | Input Sensitivity   | +   | ļ.     | ļ   |       |
| SENS            | Input Sensitivity  | With 125 kHz carrier frequency,<br>chip in default mode, 4 half bits<br>burst + 4 symbols preamble<br>and single preamble detection |     | 100    |     | μVrms |
|                 |  | Channel Settling Time   | L   | I      | 1   |       |
| TSAMP           | Amplifier settling time  |   |     | 250    |     | μs    |
|                 |  | Crystal Oscillator  |     |        |     |       |
| FXTAL           | Frequency  | Crystal dependent   |     | 32.768 |     | kHz   |
| TXTAL           | Start-up Time  | Crystal dependent   |     |        | 1   | S     |
| IXTAL           | Current consumption  |   |     | 1      |     | μA    |

| Symbol    | Parameter                    | Conditions   | Min | Тур    | Max  | Unit                                |  |  |  |  |
|-----------|------------------------------|--|-----|--------|------|-------------------------------------|--|--|--|--|
|           | External Clock Source        |  |     |        |      |                                     |  |  |  |  |
| IEXTCL    | Current consumption          |  | 1   |        | μΑ   |                                     |  |  |  |  |
|           | RC Oscillator <sup>(1)</sup> |  |     |        |      |                                     |  |  |  |  |
| FRCNCAL   |                              | If no calibration is performed                               | 27  | 32.768 | 42   | kHz                                 |  |  |  |  |
| FRCCAL32  |                              | If calibration with 32.768 kHz reference signal is performed | 31  | 32.768 | 34.5 | kHz                                 |  |  |  |  |
| FRCCALMAX | Frequency                    | Maximum achievable frequency after calibration               |     | 35     |      | kHz                                 |  |  |  |  |
| FRCCALMIN |                              | Minimum achievable frequency after calibration               |     | 30     |      | kHz                                 |  |  |  |  |
| TRC       | Start-up time                | From RC enable (R1<0> = 0)                                   |     |        | 1    | S                                   |  |  |  |  |
| TCALRC    | Calibration time             |  |     |        | 65   | Periods<br>of<br>reference<br>clock |  |  |  |  |
| IRC       | Current consumption          |  |     | 200    |      | nA                                  |  |  |  |  |

#### Note(s) and/or Footnote(s):

1. RC calibration is only successful after start-up is completed.



## Typical Operating Characteristics

Figure 12: Sensitivity over Voltage and Temperature

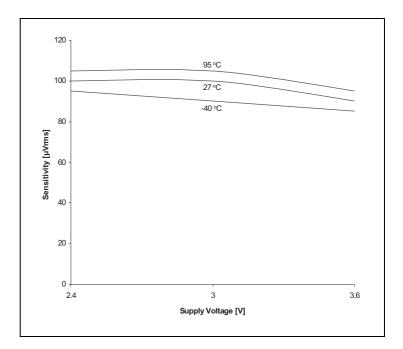


Figure 13: Sensitivity over RSSI

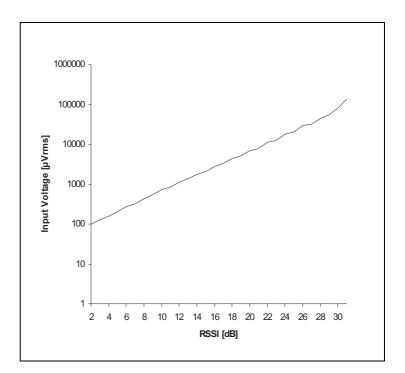
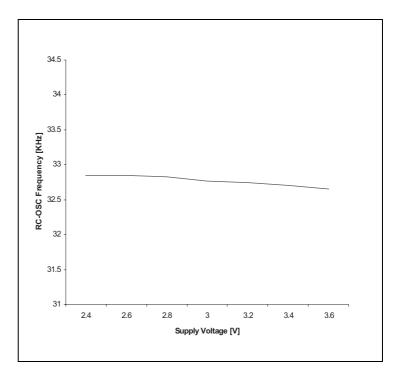
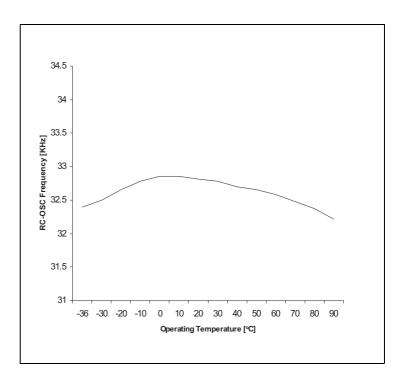




Figure 14: RC-Oscillator Frequency over Voltage (calibr.)







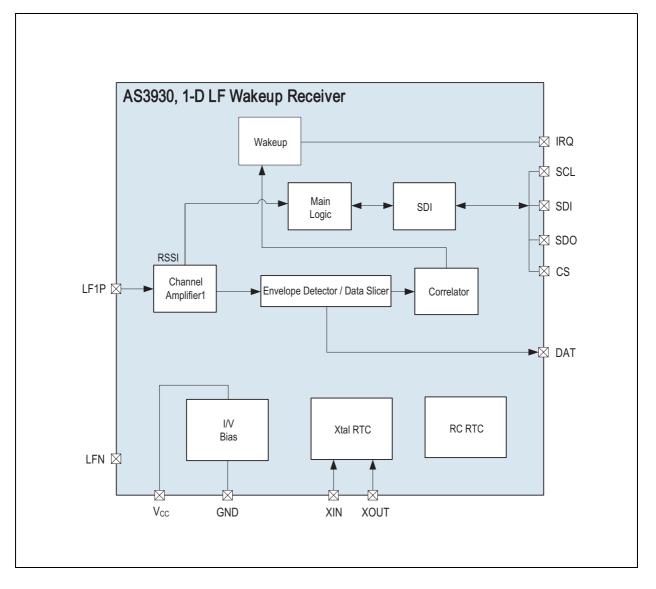
### **Detailed Description**

The AS3930 is a one-dimensional low power low-frequency wake-up receiver. The AS3930 is capable of detecting the presence of an inductive coupled carrier and extract the envelope of the ON-OFF-Keying (OOK) modulated carrier. In case the carrier is Manchester coded, then the clock is recovered from the transmitted signal and the data can be correlated with a programmed pattern. If the detected pattern corresponds to the stored one, then a wake-up signal (IRQ) is risen up. The pattern correlation can be bypassed in which case the wake-up detection is based only on the frequency detection.

The AS3930 is made up of a single receiving channel, one envelop detector, one data correlator, 8 programmable registers with the main logic and a real time clock.

The digital logic can be accessed by an SDI. The real time clock can be based on a crystal or on an internal RC. If the internal RC oscillator is used, a calibration procedure can be performed to improve its accuracy.

Figure 16: Block Diagram of LF Wake-up Receiver AS3930



AS3930 needs the following external components:

- Power supply capacitor CBAT 100 nF.
- 32.768 kHz crystal with its two pulling capacitors XTAL and CL - (it is possible to omit these components if the internal RC oscillator is used instead of the crystal oscillator).
- Input LC resonator.

In case the internal RC-oscillator is used (no crystal oscillator is mounted), the pin XIN has to be connected to the supply, while pin XOUT should stay floating. Application diagrams with and without crystal are shown in Figure 2 and Figure 3.

#### **Operating Modes**

#### Power Down Mode

In Power Down Mode AS3930 is completely switched OFF. The typical current consumption is 400 nA.

#### Listening Mode

In listening mode only the channel amplifier and the RTC are running. In this mode the system detects the presence of a carrier. In case the carrier is detected, the RSSI can be displayed.

In this mode it is possible to distinguish the following three sub modes:

#### Standard Listening Mode

The channel amplifier that is capable of detecting the presence of the carrier frequency, is active all the time.

#### ON/OFF Mode (Low Power mode)

The channel amplifier is active for one millisecond after which it is switched OFF. The OFF-time is programmable (see R4<7:6>).

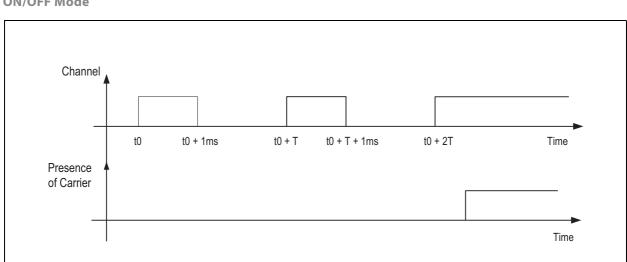


Figure 17: ON/OFF Mode

Further, for both sub modes, it is possible to enable a feature called Artificial Wake-up. If the Artificial Wake-up is enabled, then the AS3930 produces an interrupt after a certain time regardless of whether any activity is detected on the input. The period of the Artificial Wake-up is defined in the register R8<2:0>. The user can distinguish between Artificial Wake-up and Wake-up based on the field detection (frequency or pattern detection) since the Artificial Wake-up interrupt lasts only 128µs. With this interrupt the microcontroller (µC) can get feedback on the surrounding environment (e.g. read the false wake-up register R13<7:0>) and/or take actions in order to change the setup.

#### Preamble Detection / Pattern Correlation

The preamble detection and pattern correlation are only considered for the wake-up when the data correlator function is enabled (see R1<1>). The correlator searches first for preamble frequency (constant frequency of Manchester clock defined according to bit-rate transmission, see Figure 36) and then for data pattern.

If the pattern is matched, then the wake-up interrupt is displayed on the WAKE output and the chip goes in data receiving mode. If the pattern fails, then the internal wake-up is terminated and no IRQ is produced.

#### Data Receiving

After a successful wake-up the chip enters the data receiving mode. In this mode the chip can be retained a normal OOK receiver. The received data are streamed out on the pin DAT. It is possible to put the chip back to listening mode either with a direct command (CLEAR\_WAKE see Figure 24) or by using the timeout feature. This feature automatically sets the chip back to listening mode after a certain time R7<7:5>.

## System and Block Specification

### Main Logic and SDI

|     | 7        | 6              | 5       | 4           | 3        | 2           | 1           | 0      |
|-----|----------|----------------|---------|-------------|----------|-------------|-------------|--------|
| RO  | N.       | A              | ON_OFF  |             | Reserved |             | EN_A        | PWD    |
| R1  | ABS_HY   | AGC_TLIM       | AGC_UD  | ATT_ON      | N.A.     | EN_PAT2     | EN_WPAT     | EN_RTC |
| R2  | S_ABSH   | W_PAT_         | _T<1:0> |             | Reserved |             | S_WU1<1:0>  |        |
| R3  | HY_20m   | HY_POS         |         | FS_SLC<2:0> |          |             | FS_ENV<2:0> |        |
| R4  | T_OFF    | <1:0>          | R_VAL   | _<1:0>      | GR<3:0>  |             |             |        |
| R5  | TS2<7:0> |                |         |             |          |             |             |        |
| R6  |          |                |         | TS1<        | :7:0>    |             |             |        |
| R7  |          | T_OUT<2:0>     |         |             |          | T_HBIT<4:0> |             |        |
| R8  |          |                | N.A.    |             |          |             | T_AUTO<2:0> |        |
| R9  | N.A.     |                |         |             | Reserved |             |             |        |
| R10 |          | N.A RSSI1<4:0> |         |             |          |             |             |        |
| R11 | N.A      |                |         |             |          |             |             |        |
| R12 | N.A      |                |         |             |          |             |             |        |
| R13 | F_WAKE   |                |         |             |          |             |             |        |

Figure 18: Register Table



### Register Table Description and Default Values

#### Figure 19: Description and Default Values of Registers

| Register | Name     | Туре | Default Value  | Description  |
|----------|----------|------|--|--|
| R0<5>    | ON_OFF   | R/W  | 0  | ON/OFF operation mode. (Duty-cycle defined in the register R4<7:6>   |
| R0<4>    | MUX_123  | R/W  | 0  | Reserved (it is not allowed to set this bit to 1)  |
| R0<3>    | Reserved |      | 1  | Reserved   |
| R0<2>    | Reserved |      | 1  | Reserved   |
| R0<1>    | EN_A     | R/W  | 1  | Channel enable   |
| R0<0>    | PWD      | R/W  | 0  | Power down   |
| R1<7>    | ABS_HY   | R/W  | 0  | Data slicer absolute reference   |
| R1<6>    | AGC_TLIM | R/W  | 0  | AGC acting only on the first carrier burst   |
| R1<5>    | AGC_UD   | R/W  | 1  | AGC operating in both direction (up-down)  |
| R1<4>    | ATT_ON   | R/W  | 0  | Antenna damper enable  |
| R1<3>    | Reserved |      | 0  | Reserved   |
| R1<2>    | EN_PAT2  | R/W  | 0  | Double wake-up pattern correlation   |
| R1<1>    | EN_WPAT  | R/W  | 1  | Data correlation enable  |
| R1<0>    | EN_RTC   | R/W  | 1  | Crystal oscillator enable  |
| R2<7>    | S_ABSH   | R/W  | 0  | Data slicer threshold reduction  |
| R2<6:5>  | W_PAT    | R/W  | 00   | Pattern correlation tolerance (see Figure 37)  |
| R2<4:2>  | Reserved |      | 000  | Reserved   |
| R2<1:0>  | S_WU1    | R/W  | 00   | Tolerance setting for the stage wake-up (see Figure 31)  |
| R3<7>    | HY_20m   | R/W  | 0  | Data slicer hysteresis<br>if HY_20m = 0 then comparator hysteresis = 40mV<br>if HY_20m = 1 then comparator hysteresis = 20mV |
| R3<6>    | HY_POS   | R/W  | Data slicer hysteresis on both edges (HY_POS<br>0 hysteresis on both edges; HY_POS = $1 \rightarrow$ hyst<br>only on positive edges) |  |
| R3<5:3>  | FS_SCL   | R/W  | 100  | Data slicer time constant (see Figure 35)  |
| R3<2:0>  | FS_ENV   | R/W  | 000  | Envelop detector time constant (see Figure 34)   |

| Register | Name     | Туре | Default Value | Description                        |                         |  |
|----------|----------|------|---------------|------------------------------------|-------------------------|--|
|          |          |      |               | OFF time in ON/OFF                 | operation mode          |  |
|          |          |      |               | T_OFF=00                           | 1ms                     |  |
| R4<7:6>  | T_OFF    | R/W  | 00            | T_OFF=01                           | 2ms                     |  |
|          |          |      |               | T_OFF=10                           | 4ms                     |  |
|          |          |      |               | T_OFF=11                           | 8ms                     |  |
| R4<5:4>  | D_RES    | R/W  | 01            | Antenna damping r                  | esistor (see Figure 33) |  |
| R4<3:0>  | GR       | R/W  | 0000          | Gain reduction (see                | Figure 32)              |  |
| R5<7:0>  | TS2      | R/W  | 01101001      | 2 <sup>nd</sup> Byte of wake-up    | pattern                 |  |
| R6<7:0>  | TS1      | R/W  | 10010110      | 1 <sup>st</sup> Byte of wake-up    | pattern                 |  |
| R7<7:5>  | T_OUT    | R/W  | 000           | Automatic time-out (see Figure 38) |                         |  |
| R7<4:0>  | T_HBIT   | R/W  | 01011         | Bit rate definition (s             | ee Figure 36)           |  |
|          |          |      |               | Artificial wake-up                 |                         |  |
|          |          |      |               | T_AUTO=000                         | No artificial wake-up   |  |
|          |          |      |               | T_AUTO=001                         | 1 sec                   |  |
|          |          |      |               | T_AUTO=010                         | 5 sec                   |  |
| R8<2:0>  | T_AUTO   | R/W  | 000           | T_AUTO=011                         | 20 sec                  |  |
|          |          |      |               | T_AUTO=100                         | 2 min                   |  |
|          |          |      |               | T_AUTO=101                         | 15min                   |  |
|          |          |      |               | T_AUTO=110                         | 1 hour                  |  |
|          |          |      |               | T_AUTO=111                         | 2 hour                  |  |
| R9<6:0>  | Reserved |      | 000000        | Reserved                           |                         |  |
| R10<4:0> | RSSI1    | R    |               | RSSI channel                       |                         |  |
| R11<4:0> |          | R    |               | N.A.                               |                         |  |
| R12<4:0> |          | R    |               | N.A.                               |                         |  |
| R13<7:0> | F_WAK    | R    |               | False wake-up regis                | ter                     |  |



#### Serial Data Interface (SDI)

This 4-wires interface is used by the Microcontroller ( $\mu$ C) to program the AS3930. The maximum clock frequency of the SDI is 2MHz.

Figure 20: Serial Data Interface (SDI) pins

| Name | Signal                       | Signal Level | Description  |
|------|------------------------------|--------------|--|
| CS   | Digital Input with pull down | CMOS         | Chip Select  |
| SDI  | Digital Input with pull down | CMOS         | Serial Data input for writing registers, data to transmit and/or writing addresses to select readable register |
| SDO  | Digital Output               | CMOS         | Serial Data output for received data or read value of selected registers                                       |
| SCLK | Digital Input with pull down | CMOS         | Clock for serial data read and write   |

**Note(s):** SDO is set to tristate if CS is low. In this way more than one device can communicate on the same SDO bus.

**SDI Command Structure.** To program the SDI the CS signal has to go high. A SDI command is made up by a two bytes serial command and the data is sampled on the falling edge of SCLK. Figure 21 shows how the command looks like, from the MSB (B15) to LSB (B0). The command stream has to be sent to the SDI from the MSB (B15) to the LSB (B0).

Figure 21: SDI Command Structure

| Мс  | ode | Register address / Direct Command |     |     |     | Register Data |    |    |    |    |    |    |    |    |
|-----|-----|-----------------------------------|-----|-----|-----|---------------|----|----|----|----|----|----|----|----|
| B15 | B14 | B13                               | B12 | B11 | B10 | B9            | B8 | B7 | B6 | B5 | B3 | B2 | B1 | BO |

The first two bits (B15 and B14) define the operating mode. There are three modes available (write, read, direct command) plus one spare (not used), as shown in Figure 22.

Figure 22: Bits B15, B14

| B15 | B14 | Mode           |  |  |
|-----|-----|----------------|--|--|
| 0   | 0   | WRITE          |  |  |
| 0   | 1   | READ           |  |  |
| 1   | 0   | NOT ALLOWED    |  |  |
| 1   | 1   | DIRECT COMMAND |  |  |



In case a write or read command happens the next 6 bits (B13 to B8) define the register address which has to be written respectively read, as shown in Figure 23.

| B13 | B12 | B11 | B10 | B9 | B8 | Read/Write register |
|-----|-----|-----|-----|----|----|---------------------|
| 0   | 0   | 0   | 0   | 0  | 0  | RO                  |
| 0   | 0   | 0   | 0   | 0  | 1  | R1                  |
| 0   | 0   | 0   | 0   | 1  | 0  | R2                  |
| 0   | 0   | 0   | 0   | 1  | 1  | R3                  |
| 0   | 0   | 0   | 1   | 0  | 0  | R4                  |
| 0   | 0   | 0   | 1   | 0  | 1  | R5                  |
| 0   | 0   | 0   | 1   | 1  | 0  | R6                  |
| 0   | 0   | 0   | 1   | 1  | 1  | R7                  |
| 0   | 0   | 1   | 0   | 0  | 0  | R8                  |
| 0   | 0   | 1   | 0   | 0  | 1  | R9                  |
| 0   | 0   | 1   | 0   | 1  | 0  | R10                 |
| 0   | 0   | 1   | 0   | 1  | 1  | R11                 |
| 0   | 0   | 1   | 1   | 0  | 0  | R12                 |
| 0   | 0   | 1   | 1   | 0  | 1  | R13                 |

Figure 23: Bits B13-B8

The last 8 bits are the data that has to be written respectively read. A CS toggle high-low-high terminates the command mode.

If a direct command is sent (B15-B14=11) the bits from B13 to B8 defines the direct command while the last 8 bits are omitted. Figure 24 shows all possible direct commands:

Figure 24: List of Direct Commands

| COMMAND_MODE   | B13 | B12 | B11 | B10 | B9 | <b>B</b> 8 |
|----------------|-----|-----|-----|-----|----|------------|
| clear_wake     | 0   | 0   | 0   | 0   | 0  | 0          |
| reset_RSSI     | 0   | 0   | 0   | 0   | 0  | 1          |
| trim_osc       | 0   | 0   | 0   | 0   | 1  | 0          |
| clear_false    | 0   | 0   | 0   | 0   | 1  | 1          |
| preset_default | 0   | 0   | 0   | 1   | 0  | 0          |

All direct commands are explained below:

- **clear\_wake:** Clears the wake state of the chip. In case the chip has woken up (WAKE pin is high) the chip is set back to listening mode.
- reset\_RSSI: Resets the RSSI measurement.
- **trim\_osc:** Starts the trimming procedure of the internal RC oscillator (see Figure 45).
- **clear\_false:** Resets the false wake-up register (R13<7:0>=00).
- **preset\_default:** Sets all register in the default mode, as shown in Figure 19.

**Note(s):** In order to get the AS3930 work properly after sending the preset\_default direct command, it is mandatory to write R0<3>=0 and R0<2>=0.

#### Writing of Data to Addressable Registers (WRITE Mode).

The SDI is sampled at the falling edge of SCLK (as shown in the following diagrams).

A CS toggling high-low-high indicates the end of the WRITE command after register has been written. The following example shows a write command.



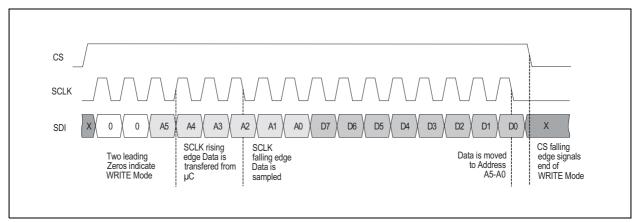
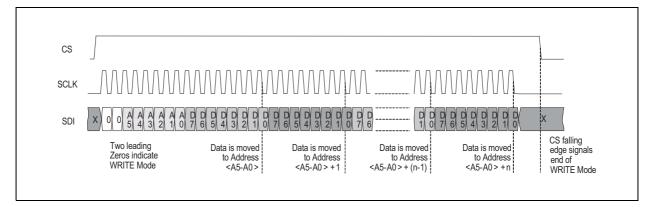


Figure 26:

Writing of Register Data with Auto-incrementing Address





#### Reading of Data from Addressable Registers (READ Mode).

Once the address has been sent through SDI, the data can be fed through the SDO pin out to the microcontroller.

A CS LOW toggling high-low-high has to be performed after finishing the read mode session, in order to indicate the end of the READ command and prepare the Interface to the next command control Byte.

To transfer bytes from consecutive addresses, SDI master has to keep the CS signal high and the SCLK clock has to be active as long as data need to be read.

Figure 27: Reading of Single Register Byte

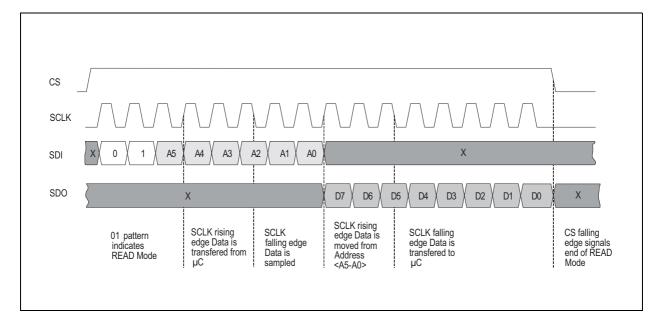
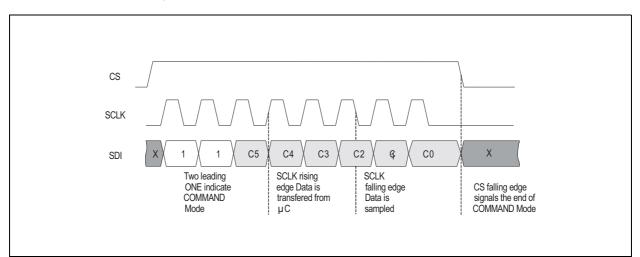


Figure 28: Send Direct COMMAND Byte



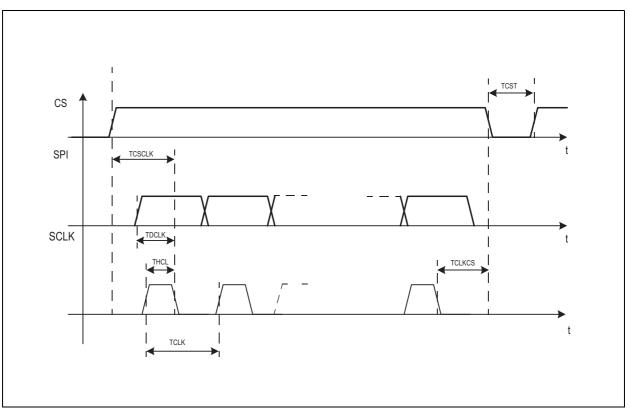


#### SDI Timing

Figure 29: SDI Timing Parameters

| Symbol | Parameter                     | Min | Тур | Max | Units |
|--------|-------------------------------|-----|-----|-----|-------|
| TCSCLK | Time CS to Sampling Data      | 500 |     |     | ns    |
| TDCLK  | Time Data to Sampling Data    | 300 |     |     | ns    |
| THCL   | SCLK High Time                | 200 |     |     | ns    |
| TCLK   | SCLK period                   | 500 |     |     | ns    |
| TCLKCS | Time Sampling Data to CS down | 500 |     |     | ns    |
| TCST   | CS Toggling time              | 500 |     |     | ns    |





### **Channel Amplifier and Frequency Detector**

The channel amplifier consists of a variable gain amplifier (VGA), an automatic gain control, and a frequency detector. The latter detects the presence of a carrier. As soon as the carrier is detected the AGC is enabled, the gain of the VGA is reduced and set to the right value and the RSSI can be displayed.



#### Frequency Detector / AGC

The frequency detection uses the RTC as time base. In case the internal RC oscillator is used as RTC, it must be calibrated, but the calibration is guaranteed for a 32.768 kHz crystal oscillator only. The frequency detection criteria can be tighter or more relaxed according to the setup described in R2<1:0> (see Figure 31).

#### Figure 31:

**Tolerance Settings for Wake-up** 

| R2<1> | R2<0> | Tolerance        |  |  |
|-------|-------|------------------|--|--|
| 0     | 0     | Relaxed          |  |  |
| 0     | 1     | Tighter (Medium) |  |  |
| 1     | 0     | Stringent        |  |  |
| 1     | 1     | Reserved         |  |  |

The AGC can operate in two modes:

- AGC down only (R1<5>=0)
- AGC up and down (R1<5>=1)

As soon as the AGC starts to operate, the gain in the VGA is set to maximum. If the AGC down only mode is selected, the AGC can only decrease the gain. Since the RSSI is directly derived from the VGA gain, the system holds the RSSI peak.

When the AGC up and down mode is selected, the RSSI can follow the input signal strength variation in both directions.

Regardless which AGC operation mode is used, the AGC needs maximum 35 carrier periods to settle.

The RSSI is stored in the register R10 < 4:0 >.

Both AGC modes (only down or down and up) can also operate with time limitation. This option allows AGC operation only in time slot of  $256\mu$ s following the internal wake-up. Then the AGC (RSSI) is frozen till the wake-up or RSSI reset occurs.

The RSSI is reset either with the direct command 'clear\_wakeup' or 'reset\_RSSI'. The 'reset\_RSSI' command resets only the AGC setting but does not terminate wake-up condition. This means that if the signal is still present the new AGC setting (RSSI) will appear not later than 300µs (35 LF carrier periods) after the command was received. The AGC setting is reset if for duration of 3 Manchester half symbols no carrier is detected. If the wake-up IRQ is cleared the chip will go back to listening mode.

In case the maximum amplification at the beginning is a drawback (e.g. in noisy environment) it is possible to set a smaller starting gain on the amplifier Figure 32. In this way it is possible to reduce the false frequency detection.

#### Figure 32: Bit Setting of Gain Reduction

| R4<3> | R4<2> | R4<1> | R4<0>  | Gain Reduction    |
|-------|-------|-------|--------|-------------------|
| 0     | 0     | 0     | 0      | No gain reduction |
| 0     | 0     | 0     | 1      | N.A               |
| 0     | 0     | 1     | 0 or 1 | N.A               |
| 0     | 1     | 0     | 0 or 1 | -4dB              |
| 0     | 1     | 1     | 0 or 1 | -8dB              |
| 1     | 0     | 0     | 0 or 1 | -12dB             |
| 1     | 0     | 1     | 0 or 1 | -16dB             |
| 1     | 1     | 0     | 0 or 1 | -20dB             |
| 1     | 1     | 1     | 0 or 1 | -24dB             |

#### Antenna Damper

The antenna damper allows the chip to deal with higher field strength, it is enabled by register R1<4>. It consists of shunt resistors which degrade the quality factor of the resonator by reducing the signal at the input of the amplifier. In this way the resonator sees a smaller parallel resistance (in the band of interest) which degrades its quality factor in order to increase the linear range of the channel amplifier (the amplifier doesn't saturate in presence of bigger signals). Figure 33 shows the bit setup.

Figure 33: Antenna Damper Bit Setup

| R4<5> | R4<4> | Shunt resistor (parallel to the resonator at 125 kHz) |
|-------|-------|---|
| 0     | 0     | 1 kΩ  |
| 0     | 1     | 3 kΩ  |
| 1     | 0     | 9 kΩ  |
| 1     | 1     | 27 kΩ   |



#### **Demodulator / Data Slicer**

The performance of the demodulator can be optimized according to bit rate and preamble length as described in Figure 34 and Figure 35.

Figure 34:

**Bit Setup for Envelop Detector for Different Symbol Rates** 

| R3<2> | R3<1> | R3<0> | Symbol Rate<br>[Manchester symbol/s] |
|-------|-------|-------|--------------------------------------|
| 0     | 0     | 0     | 4096                                 |
| 0     | 0     | 1     | 2184                                 |
| 0     | 1     | 0     | 1490                                 |
| 0     | 1     | 1     | 1130                                 |
| 1     | 0     | 0     | 910                                  |
| 1     | 0     | 1     | 762                                  |
| 1     | 1     | 0     | 655                                  |
| 1     | 1     | 1     | 512                                  |

If the bit rate gets higher, the time constant in the envelop detector must be set to a smaller value. This means that higher noise is injected because of the wider band. The next table is a rough indication of how the envelop detector looks like for different bit rates. By using proper data slicer settings it is possible to improve the noise immunity paying the penalty of a longer preamble. In fact if the data slicer has a bigger time constant it is possible to reject more noise, but every time a transmission occurs, the data slicer need time to settle. This settling time will influence the length of the preamble. Figure 35 gives a correlation between data slicer setup and minimum required preamble length.

| R3<5> | R3<4> | R3<3> | Minimum Preamble<br>Length [ms] |
|-------|-------|-------|---------------------------------|
| 0     | 0     | 0     | 0.8                             |
| 0     | 0     | 1     | 1.15                            |
| 0     | 1     | 0     | 1.55                            |
| 0     | 1     | 1     | 1.9                             |
| 1     | 0     | 0     | 2.3                             |
| 1     | 0     | 1     | 2.65                            |
| 1     | 1     | 0     | 3                               |
| 1     | 1     | 1     | 3.5                             |

Figure 35: Bit Setup for Data Slicer for Different Preamble Length

**Note(s):** These times are minimum required, but it is recommended to prolong the preamble.

The comparator of the data slicer can work only with positive or with symmetrical threshold R3<6>. In addition the threshold can be 20 or 40 mV R3<7>. In case the length of the preamble is an issue the data slicer can also work with an absolute threshold R1<7>. In this case the bits R3<2:0> would not influence the performance. It is even possible to reduce the absolute threshold in case the environment is not particularly noisy R2<7>.

#### Correlator

After frequency detection the data correlation is only performed if the correlator is enabled (R1 < 1 > = 1).

The data correlation consists of checking the presence of a preamble (ON/OFF modulated carrier) followed by a certain pattern.

After the frequency detection the correlator waits 16 bits (see bit rate definition in Figure 36) and if no preamble is detected the chip is set back to listening mode and the false wake-up register (R13<7:0>) is incremented by one.

To get started with the pattern correlation the correlator needs to detect at least 4 bits of the preamble (ON/OFF modulated carrier).

The bit duration is defined in the register R7<4:0>(Figure 36) as function of the Real Time Clock (RTC) periods.



Figure 36: Bit Rate Setup

| R7<br><4> | R7<br><3> | R7<br><2> | R7<br><1> | R7<br><0> | Bit Duration in<br>RTC Clock Periods | Bit Rate<br>(bits/s) | Symbol Rate<br>(Manchester symbols/s) |
|-----------|-----------|-----------|-----------|-----------|--------------------------------------|----------------------|---------------------------------------|
| 0         | 0         | 0         | 1         | 1         | 4                                    | 8192                 | 4096                                  |
| 0         | 0         | 1         | 0         | 0         | 5                                    | 6552                 | 3276                                  |
| 0         | 0         | 1         | 0         | 1         | 6                                    | 5460                 | 2730                                  |
| 0         | 0         | 1         | 1         | 0         | 7                                    | 4680                 | 2340                                  |
| 0         | 0         | 1         | 1         | 1         | 8                                    | 4096                 | 2048                                  |
| 0         | 1         | 0         | 0         | 0         | 9                                    | 3640                 | 1820                                  |
| 0         | 1         | 0         | 0         | 1         | 10                                   | 3276                 | 1638                                  |
| 0         | 1         | 0         | 1         | 0         | 11                                   | 2978                 | 1489                                  |
| 0         | 1         | 0         | 1         | 1         | 12                                   | 2730                 | 1365                                  |
| 0         | 1         | 1         | 0         | 0         | 13                                   | 2520                 | 1260                                  |
| 0         | 1         | 1         | 0         | 1         | 14                                   | 2340                 | 1170                                  |
| 0         | 1         | 1         | 1         | 0         | 15                                   | 2184                 | 1092                                  |
| 0         | 1         | 1         | 1         | 1         | 16                                   | 2048                 | 1024                                  |
| 1         | 0         | 0         | 0         | 0         | 17                                   | 1926                 | 963                                   |
| 1         | 0         | 0         | 0         | 1         | 18                                   | 1820                 | 910                                   |
| 1         | 0         | 0         | 1         | 0         | 19                                   | 1724                 | 862                                   |
| 1         | 0         | 0         | 1         | 1         | 20                                   | 1638                 | 819                                   |
| 1         | 0         | 1         | 0         | 0         | 21                                   | 1560                 | 780                                   |
| 1         | 0         | 1         | 0         | 1         | 22                                   | 1488                 | 744                                   |
| 1         | 0         | 1         | 1         | 0         | 23                                   | 1424                 | 712                                   |
| 1         | 0         | 1         | 1         | 1         | 24                                   | 1364                 | 682                                   |
| 1         | 1         | 0         | 0         | 0         | 25                                   | 1310                 | 655                                   |
| 1         | 1         | 0         | 0         | 1         | 26                                   | 1260                 | 630                                   |
| 1         | 1         | 0         | 1         | 0         | 27                                   | 1212                 | 606                                   |
| 1         | 1         | 0         | 1         | 1         | 28                                   | 1170                 | 585                                   |
| 1         | 1         | 1         | 0         | 0         | 29                                   | 1128                 | 564                                   |
| 1         | 1         | 1         | 0         | 1         | 30                                   | 1092                 | 546                                   |
| 1         | 1         | 1         | 1         | 0         | 31                                   | 1056                 | 528                                   |
| 1         | 1         | 1         | 1         | 1         | 32                                   | 1024                 | 512                                   |

If the preamble is detected correctly the correlator keeps searching for a data pattern. The duration of the preamble plus the pattern should not be longer than 40 bits (see bit rate definition in Figure 36). The data pattern can be defined by the user and consists of two bytes which are stored in the registers R5<7:0> and R6<7:0>. The two bytes define the pattern and the bit period can be selected by the user. The only limitation is that the pattern (in combination with preamble) must obey Manchester coding and timing. It must be noted that according to Manchester coding a down-to-up bit transition represents a symbol "0", while a transition up-to-down represents a symbol "1". If the default code is used (96 [hex]) the binary code is (10 01 01 10 01 10 01). MSB has to be transmitted first.

The user can also select (R1<2>) if single or double data pattern is used for wake-up. In case double pattern detection is set, the same pattern has to be repeated 2 times.

Additionally it is possible to set the number of allowed missing zero bits (not symbols) in the received bitstream (R2<6:5>), as shown in the Figure 37.

Figure 37: Allowed Pattern Detection Errors

| R2<6> | R2<5> | Maximum allowed error in the pattern detection |
|-------|-------|--|
| 0     | 0     | No error allowed                               |
| 0     | 1     | 1 missed zero                                  |
| 1     | 0     | 2 missed zeros                                 |
| 1     | 1     | 3 missed zeros                                 |

If the pattern matches the wake-up, interrupt is displayed on the WAKE output.

If the pattern detection fails, the internal wake-up (on all active channels) is terminated with no signal sent to MCU and the false wake-up register will be incremented (R13<7:0>).

The wake-up state is terminated with the direct command 'clear\_wake' (see Figure 24). This command terminates the MCU activity. The termination can also be automatic in case there is no response from MCU. The time out for automatic termination is set in a register R7<7:5>, as shown in the Figure 38.



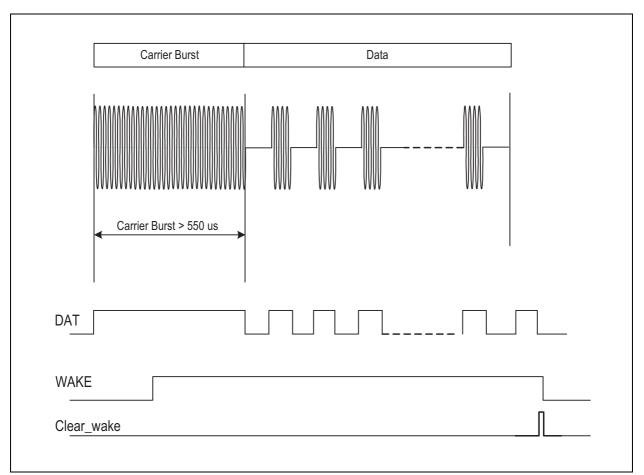
#### Figure 38: Timeout Setup

| R7<7> | R7<6> | R7<5> | Time out |
|-------|-------|-------|----------|
| 0     | 0     | 0     | 0 sec    |
| 0     | 0     | 1     | 50 msec  |
| 0     | 1     | 0     | 100 msec |
| 0     | 1     | 1     | 150 msec |
| 1     | 0     | 0     | 200 msec |
| 1     | 0     | 1     | 250 msec |
| 1     | 1     | 0     | 300 msec |
| 1     | 1     | 1     | 350 msec |

## Wake-up Protocol - Carrier Frequency 125 kHz

#### Without Pattern Detection

Figure 39: Wake-up Protocol Overview without Pattern Detection (only carrier frequency detection)



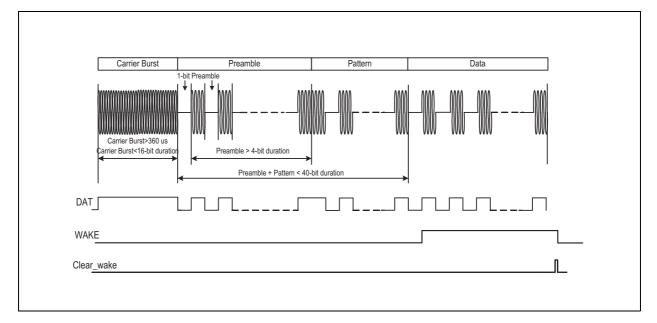
In case the data correlation is disabled (R1<1>=0) the AS3930 wakes up upon detection of the carrier frequency only as shown in Figure 39. In order to ensure that AS3930 wakes up the carrier burst has to last longer than 550  $\mu$ s. To set AS3930 back to listening mode there are two possibilities: either the microcontroller sends the direct command clear\_wake via SDI or the time out option is used (R7<7:5>). In case the latter is chosen, AS3930 is automatically set to listening mode after the time defined in T\_OUT (R7<7:5>), counting starts at the low-to-high WAKE edge on the WAKE pin.

#### Single Pattern Detection

The Figure 40 shows the wake-up protocol in case the pattern correlation is enabled (R1<1>=1) for a 125 kHz carrier frequency. The initial carrier burst has to be longer than 550 µs and can last maximum 16 bits (see bit rate definition in Figure 36). If the ON/OFF mode is used (R1<5>=1), the minimum value of the maximum carrier burst duration is limited to 10 ms. This is summarized in Figure 41. In case the carrier burst is too long the internal wake-up will be set back to low and the false wake-up counter (R13<7:0>) will be incremented by one.

The carrier burst must be followed by a preamble (0101... modulated carrier with a bit duration defined in Figure 36) and the wake-up pattern stored in the registers R5<7:0> and R6<7:0>. The preamble must have at least 4 bits and the preamble duration together with the pattern should not be longer than 40 bits. If the wake-up pattern is correct, the signal on the WAKE pin goes high one bit after the end of the pattern and the data transmission can get started. To set the chip back to listening mode the direct command clear\_wake, as well as the time out option ( R7<7:5>) can be used.

Figure 40: Wake-up Protocol Overview with Single Pattern Detection



#### Figure 41:

Preamble Requirements in Standard Mode, Scanning Mode and ON/OFF Mode

| Bit Rate<br>(bits/s) | Maximum Duration of the Carrier Burst in Standard Mode and Scanning Mode (ms) | Maximum Duration of the Carrier<br>Burst in ON/OFF Mode (ms) |
|----------------------|---|--|
| 8192                 | 1.95  | 10   |
| 6552                 | 2.44  | 10   |
| 5460                 | 2.93  | 10   |
| 4680                 | 3.41  | 10   |
| 4096                 | 3.90  | 10   |
| 3640                 | 4.39  | 10   |
| 3276                 | 4.88  | 10   |
| 2978                 | 5.37  | 10   |
| 2730                 | 5.86  | 10   |
| 2520                 | 6.34  | 10   |
| 2340                 | 6.83  | 10   |
| 2184                 | 7.32  | 10   |
| 2048                 | 7.81  | 10   |
| 1926                 | 8.30  | 10   |
| 1820                 | 8.79  | 10   |
| 1724                 | 9.28  | 10   |
| 1638                 | 9.76  | 10   |
| 1560                 | 10.25   | 10.25  |
| 1488                 | 10.75   | 10.75  |
| 1424                 | 11.23   | 11.23  |
| 1364                 | 11.73   | 11.73  |
| 1310                 | 12.21   | 12.21  |
| 1260                 | 12.69   | 12.69  |
| 1212                 | 13.20   | 13.20  |
| 1170                 | 13.67   | 13.67  |
| 1128                 | 14.18   | 14.18  |
| 1092                 | 14.65   | 14.65  |
| 1056                 | 15.15   | 15.15  |
| 1024                 | 15.62   | 15.62  |

### False Wake-up Register

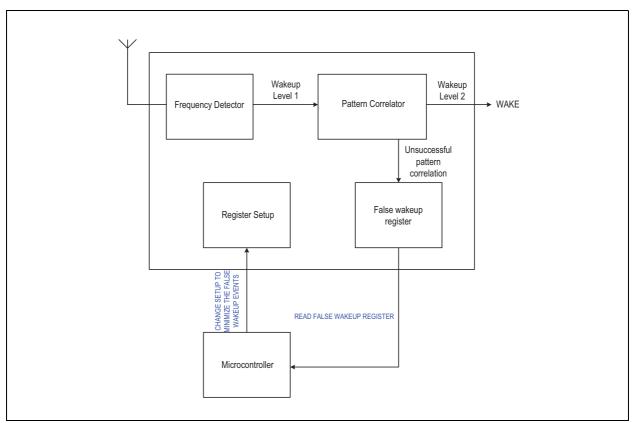
The wake-up strategy in the AS3930 is based on 2 steps:

- 1. **Frequency Detection:** In this phase the frequency of the received signal is checked.
- 2. **Pattern Correlation:** Here the pattern is demodulated and checked whether it corresponds to the valid one.

If there is a disturber or noise capable to overcome the first step (frequency detection) without producing a valid pattern, then a false wake-up call happens.Each time this event is recognized a counter is incremented by one and the respective counter value is stored in a memory cell (false wake-up register). Thus, the microcontroller can periodically look at the false wake-up register, to get a feeling how noisy the surrounding environment is and can then react accordingly (e.g. reducing the gain of the LNA during frequency detection, set the AS3930 temporarily to power down etc.), as shown in the Figure 42. The false wake-up counter is a useful tool to quickly adapt the system to any changes in the noise environment and thus avoid false wake-up events.

Most wake-up receivers have to deal with environments that can rapidly change. By periodically monitoring the number of false wake-up events it is possible to adapt the system setup to the actual characteristics of the environment and enables a better use of the full flexibility of AS3930.

#### Figure 42: Concept of the False Wake-up Register Together with System





### Real Time Clock (RTC)

The RTC can be based on a crystal oscillator (R1<0>=1), the internal RC-oscillator (R1<0>=0), or an external clock source (R1<0>=1). The crystal has higher precision of the frequency but a higher current consumption and needs three external components (crystal plus two capacitors). The RC-oscillator is completely integrated and can be calibrated if a reference signal is available for a very short time to improve the frequency accuracy. The calibration gets started with the trim\_osc direct command. Since no non-volatile memory is available the calibration must be done every time after the RCO was turned OFF. The RCO is turned OFF when the chip is in power down mode, a POR happened, or the crystal oscillator is enabled. Since the RTC defines the time base of the frequency detection, the selected frequency (frequency of the crystal oscillator or the reference frequency used for calibration of the RC oscillator) should be about one forth of the carrier frequency:

(EQ1)  $F_{RTC} \sim F_{CAR}^* 0.25$ 

#### Where:

F<sub>CAR</sub> is the carrier frequency

F<sub>RTC</sub> is the RTC frequency

**Note(s):** The third option for the RTC is the use of an external clock source, which must be applied directly to the XIN pin (XOUT floating).

#### **Crystal Oscillator**

Figure 43: Characteristics of XTAL

| Parameter   | Conditions        | Min | Тур    | Max  | Units  |
|---|-------------------|-----|--------|------|--------|
| Crystal accuracy (initial)                            | Overall accuracy  |     |        | ±120 | p.p.m. |
| Crystal motional resistance                           |                   |     |        | 60   | KΩ     |
| Frequency   |                   |     | 32.768 |      | kHz    |
| Contribution of the oscillator to the frequency error |                   |     | ±5     |      | p.p.m  |
| Start-up Time   | Crystal dependent |     | 1      |      | S      |
| Duty cycle  |                   | 45  | 50     | 55   | %      |
| Current consumption                                   |                   |     | 1      |      | μΑ     |



#### **RC-Oscillator**

### Figure 44:

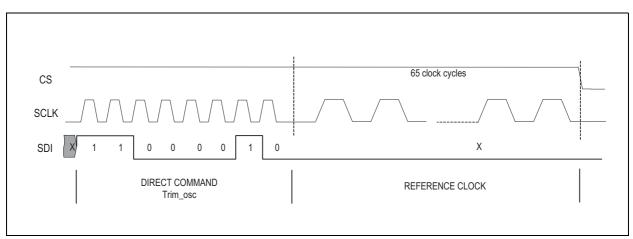
**Characteristics of RCO** 

| Parameter                                 | Conditions                     | Min | Тур    | Max  | Units  |
|---|--------------------------------|-----|--------|------|--------|
| Frequency                                 | If no calibration is performed | 27  | 32.768 | 42   | kHz    |
| riequency                                 | If calibration is performed    | 31  | 32.768 | 34.5 | kHz    |
| Calibration time Periods of reference clo |                                |     |        | 65   | cycles |
| Current consumption                       |                                |     | 200    |      | nA     |

To trim the RC-Oscillator, set the chip select (CS) to high before sending the direct command trim\_osc over SDI. Then 65 digital clock cycles of the reference clock (e.g. 32.768 kHz) have to be sent on the clock bus (SCLK), as shown in Figure 45. After that the signal on the chip select (CS) has to be pulled down.

The calibration is effective after the 65th reference clock edge and it will be stored in a volatile memory. In case the RC-oscillator is switched OFF or a power-ON-reset happens (e.g. battery change) the calibration has to be repeated.

#### Figure 45: RC-Oscillator Calibration via SDI



#### **External Clock Source**

To clock the AS3930 with an external signal the crystal oscillator has to be enabled (R1<0>=1). As shown in the Figure 4 the clock must be applied on the pin XIN while the pin XOUT must stay floating. The RC time constant has to be 100 $\mu$ s with a tolerance of ±10% (e.g. R=680 k $\Omega$  and C=22pF). In the Figure 46 the clock characteristics are summarized.



#### Figure 46: Characteristics of External Clock

| Symbol    | Parameter        | Min                   | Тур | Мах                   | Units |
|-----------|------------------|-----------------------|-----|-----------------------|-------|
| VI        | Low level        | 0                     |     | 0.1 * V <sub>DD</sub> | V     |
| Vh        | High level       | 0.9 * V <sub>DD</sub> |     | V <sub>DD</sub>       | V     |
| Tr        | Rise-time        |                       |     | 3                     | μs    |
| Tf        | Fall-time        |                       |     | 3                     | μs    |
| T =1/2πRC | RC Time constant | 90                    | 100 | 110                   | μs    |

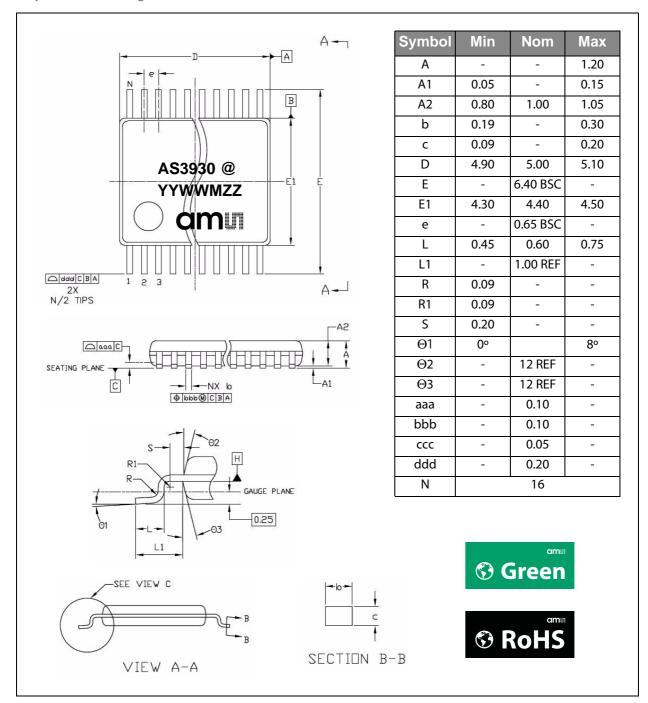
Note(s): In power down mode the external clock has to be set to  $\mathsf{V}_{\mathsf{DD}}.$ 



## Package Drawings & Markings

The product is available in a 16-pin TSSOP and QFN 4×4 16 LD package.

Figure 47: 16-pin TSSOP Package



#### Note(s) and/or Footnote(s):

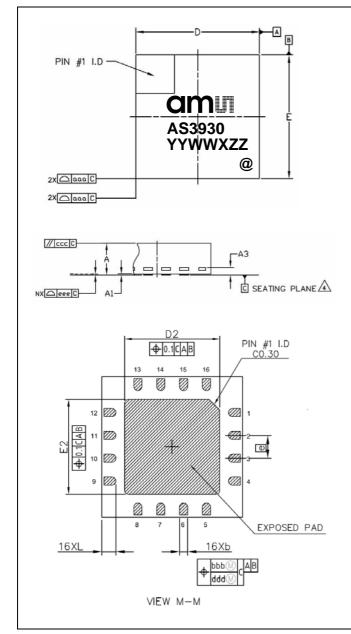
1. Dimensions and tolerancing conform to ASME Y14.5M-1994.

2. All dimensions are in millimeters. Angles are in degrees.

Figure 48: Marking: @YYWWMZZ

| @                 | ΥY   | WW                 | Μ                         | ZZ                         |
|-------------------|------|--------------------|---------------------------|----------------------------|
| Sublot identifier | Year | Manufacturing Week | Assembly plant identifier | Assembly traceability code |

#### Figure 49: QFN 4× 4 16 LD Package



| EVEN/ODD TERMINAL SIDE |      |           |      |  |  |  |
|------------------------|------|-----------|------|--|--|--|
| Symbol                 | Min  | Nom       | Max  |  |  |  |
| А                      | 0.80 | 0.85      | 0.90 |  |  |  |
| A1                     | 0    |           | 0.05 |  |  |  |
| A3                     |      | 0.203 REF |      |  |  |  |
| b                      | 0.18 | 0.23      | 0.28 |  |  |  |
| D                      |      | 4.00 BSC  |      |  |  |  |
| E                      |      | 4.00 BSC  |      |  |  |  |
| D2                     | 2.60 | 2.70      | 2.80 |  |  |  |
| E2                     | 2.60 | 2.70      | 2.80 |  |  |  |
| e                      |      | 0.65 BSC  |      |  |  |  |
| L                      | 0.35 | 0.40      | 0.45 |  |  |  |
| L1                     | 0.00 |           | 0.10 |  |  |  |
| ааа                    |      | 0.10      |      |  |  |  |
| bbb                    |      | 0.10      |      |  |  |  |
| ссс                    |      | 0.10      |      |  |  |  |
| ddd                    |      | 0.05      |      |  |  |  |
| eee                    |      | 0.08      |      |  |  |  |

n

#### Note(s) and/or Footnote(s):

- 1. Dimensions and tolerancing conform to ASME Y14.5M-1994.
- 2. All dimensions are in millimeters. Angles are in degrees.
- 3. Dimension b applies to metallized terminal and is measured between 0.25mm and 0.30mm from terminal tip. Dimension L1 represents terminal full back from package edge up to 0.15mm is acceptable.
- 4. Coplanarity applies to the exposed heat slug as well as the terminal.
- 5. Radius on terminal is optional.

Figure 50: Marking: YYWWXZZ@

| YY   | WW                 | Х                         | ZZ                         | @                 |
|------|--------------------|---------------------------|----------------------------|-------------------|
| Year | Manufacturing Week | Assembly plant identifier | Assembly traceability code | Sublot identifier |



## **Ordering & Contact Information**

Figure 51: Ordering Information

| Ordering<br>Code | Туре           | Marking | Delivery Form <sup>(1)</sup> | Delivery Quantity |
|------------------|----------------|---------|------------------------------|-------------------|
| AS3930-BTST      | 16-pin TSSOP   | AS3930  | 7 inches Tape & Reel         | 1000 pcs          |
| AS3930-BQFT      | QFN (4×4) 16LD | AS3930  | 7 inches Tape & Reel         | 1000 pcs          |

#### Note(s) and/or Footnote(s):

1. Dry Pack: Moisture Sensitivity Level (MSL) = 3, according to IPC/JEDEC J-STD-033A.

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| Document Status          | Product Status  | Definition   |
|--------------------------|-----------------|--|
| Product Preview          | Pre-Development | Information in this datasheet is based on product ideas in<br>the planning phase of development. All specifications are<br>design goals without any warranty and are subject to<br>change without notice   |
| Preliminary Datasheet    | Pre-Production  | Information in this datasheet is based on products in the<br>design, validation or qualification phase of development.<br>The performance and parameters shown in this document<br>are preliminary without any warranty and are subject to<br>change without notice            |
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## **Revision Information**

| Changes from 1.5 (2013-Feb-04) to current revision 1-62 (2014-Nov-27) | Page |
|---|------|
| Content was updated to the latest <b>ams</b> design                   |      |
| Updated General Description & Figure 1                                | 1    |
| Updated Pin Assignments section                                       | 4    |
| Added TRC (start-up time) parameter in Figure 11 and a note under it  | 8    |
| Updated Figure 29   | 22   |
| Updated Package Drawings & Markings section                           | 36   |

#### Note(s) and/or Footnote(s):

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.

2. Correction of typographical errors is not explicitly mentioned.

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- 2 Applications
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- 4 16-pin TSSOP
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